

P-Channel 40 V (D-S) MOSFET

PRODUCT SUMMARY				
V _{DS} (V)	- 40			
$R_{DS(on)}(\Omega)$ at $V_{GS} = -10 \text{ V}$	0.006			
$R_{DS(on)}(\Omega)$ at $V_{GS} = -4.5 \text{ V}$	0.007			
I _D (A)	-80			
Configuration	Single			

FEATURES

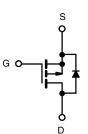
- Halogen-free According to IEC 61249-2-21 Definition
- SGT technology Power MOSFET
- Package with Low Thermal Resistance
- 100 % R_g and UIS Tested
- Compliant to RoHS Directive 2002/95/EC







Top View



P-Channel MOSFET

PARAMETER PARAMETER	SYMBOL	LIMIT	UNIT	
Drain-Source Voltage	V _{DS}	- 40	V	
Gate-Source Voltage	V _{GS}	± 20		
Continuous Drain Current	T _C = 25 °C	I_	-80	
	T _C = 125 °C	I _D	-50	
Continuous Source Current (Diode Conduct	ion) ^a	I _S	-70	Α
Pulsed Drain Current ^b		I _{DM}	-240	
Single Pulse Avalanche Current	L = 0.1 mH	I _{AS}	-70	
Single Pulse Avalanche Energy	L = U.1 IIII	E _{AS}	1345	mJ
Maximum Power Dissipation ^b	T _C = 25 °C	P _D	250	W
	T _C = 125 °C	гD	100	VV
Operating Junction and Storage Temperatur	re Range	T _J , T _{stg}	- 55 to + 150	°C

THERMAL RESISTANCE RATINGS						
PARAMETER	SYMBOL	LIMIT	UNIT			
Junction-to-Ambient	PCB Mount ^c	R_{thJA}	50	°C/W		
Junction-to-Case (Drain)	on-to-Case (Drain)		0.6	G/ VV		

Notes

- a. Package limited.
- b. Pulse test; pulse width \leq 300 µs, duty cycle \leq 2 %.
- c. When mounted on 1" square PCB (FR-4 material).
- d. Parametric verification ongoing.

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PARAMETER	SYMBOL	vise noted) TEST CONDITIONS		MIN.	TYP.	MAX.	UNIT	
Static								
Drain-Source Breakdown Voltage	V _{DS}	$V_{GS} = 0 \text{ V}, I_D = -250 \mu\text{A}$		- 40	-	-	.,	
Gate-Source Threshold Voltage	V _{GS(th)}	V _{DS} =	$V_{DS} = V_{GS}, I_{D} = -250 \mu\text{A}$		-	-3.0	V	
Gate-Source Leakage	I _{GSS}	V _{DS} =	$0 \text{ V}, \text{ V}_{GS} = \pm 20 \text{ V}$	-	-	± 100	nA	
		V _{GS} = 0 V	V _{DS} = - 40 V	-	-	- 1	1	
Zero Gate Voltage Drain Current	I _{DSS}	V _{GS} = 0 V	V _{DS} = - 40 V, T _J = 125 °C	1	-	- 50	μΑ	
		V _{GS} = 0 V	V _{DS} = - 40 V, T _J = 150°C	-	-	- 250	1	
On-State Drain Current ^a	I _{D(on)}	V _{GS} = - 10 V	$V_{DS} \le -5 V$	- 30	-	-	Α	
Drain-Source On-State Resistance ^a		V _{GS} = - 10 V	I _D = - 20 A	-	0.006	-	Ω	
	В	V _{GS} = - 10 V	I _D = - 20 A, T _J = 125 °C	1	0.009	-		
	R _{DS(on)}	V _{GS} = - 10 V	I _D = - 20 A, T _J = 150 °C	-	0.015	-		
		V _{GS} = - 4.5 V	I _D = -20 A	1	0.008	-		
Forward Transconductance ^b	9 _{fs}	V _{DS} = - 15 V, I _D = -20 A		-	35	-	S	
Dynamic ^b								
Input Capacitance	C _{iss}			-	8000	-		
Output Capacitance	C _{oss}	$V_{GS} = 0 V$	V _{DS} = - 25 V, f = 1 MHz	-	301	-	pF	
Reverse Transfer Capacitance	C _{rss}	1		-	208	-		
Total Gate Charge ^c	Qg			-	96	144		
Gate-Source Charge ^c	Q _{gs}	V _{GS} = - 10 V	$V_{DS} = -50V, I_{D} = -9.2 A$	-	8.4	-	nC	
Gate-Drain Charge ^c	Q _{gd}	1		-	23.5	-		
Gate Resistance	R_g	f = 1 MHz		1.5	3.13	4.7	Ω	
Turn-On Delay Time ^c	t _{d(on)}	$V_{DD} = -50 \text{ V}, R_L = 6.49 \Omega$ $I_D \cong -7.7 \text{ A}, V_{GEN} = -10 \text{ V}, R_g = 1.0 \Omega$		-	11	17		
Rise Time ^c	t _r			-	11	17	ns	
Turn-Off Delay Time ^c	t _{d(off)}			-	78	117		
Fall Time ^c	t _f			-	15	23		
Source-Drain Diode Ratings and Chara	acteristics ^b							
Pulsed Current ^a	I _{SM}			-	-	- 240	Α	
Forward Voltage	V_{SD}	I _F = - 7.7 A, V _{GS} = 0 V			- 0.8	- 1.5	V	

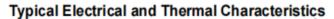
Notes

- a. Pulse test; pulse width $\leq 300~\mu s,$ duty cycle $\leq 2~\%.$
- b. Guaranteed by design, not subject to production testing.
- c. Independent of operating temperature.

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

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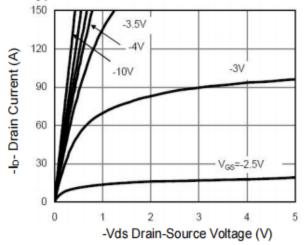


Figure 1 Output Characteristics

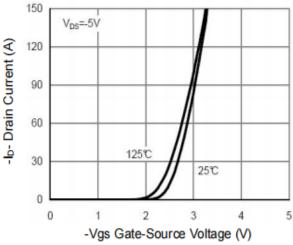


Figure 2 Transfer Characteristics

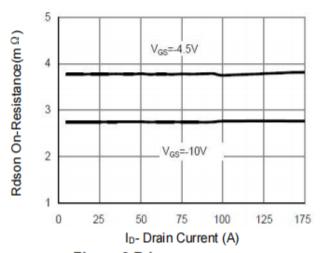


Figure 3 Rdson- Drain Current

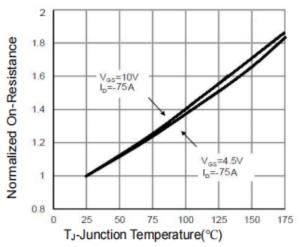


Figure 4 Rdson-JunctionTemperature

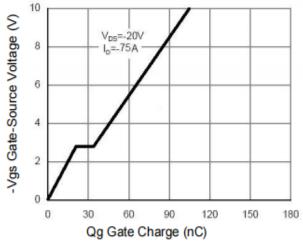


Figure 5 Gate Charge

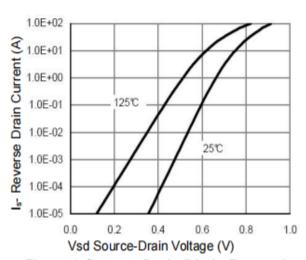


Figure 6 Source- Drain Diode Forward

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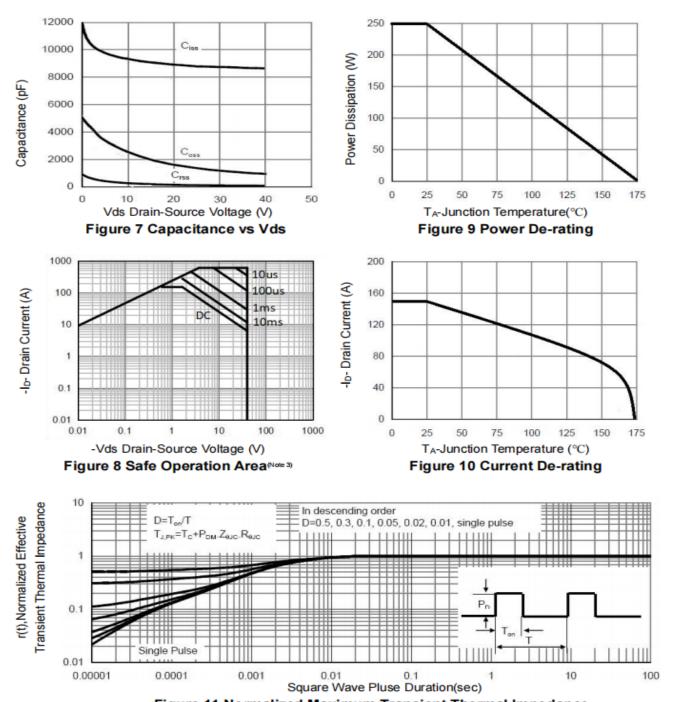
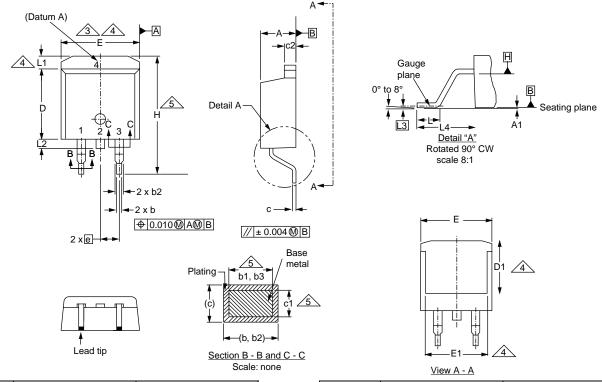


Figure 11 Normalized Maximum Transient Thermal Impedance

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TO-263



	MILLIN	METERS	INC	HES
DIM.	MIN.	MAX.	MIN.	MAX.
А	4.06	4.83	0.160	0.190
A1	0.00	0.25	0.000	0.010
b	0.51	0.99	0.020	0.039
b1	0.51	0.89	0.020	0.035
b2	1.14	1.78	0.045	0.070
b3	1.14	1.73	0.045	0.068
С	0.38	0.74	0.015	0.029
c1	0.38	0.58	0.015	0.023
c2	1.14	1.65	0.045	0.065
D	8.38	9.65	0.330	0.380

	MILLIN	METERS	INC	HES	
DIM.	MIN.	MAX.	MIN.	MAX.	
D1	6.86	-	0.270	-	
Е	9.65	10.67	0.380	0.420	
E1	6.22	ı	0.245	-	
е	2.54	BSC	0.100 BSC		
Н	14.61	15.88	0.575	0.625	
L	1.78	2.79	0.070	0.110	
L1	-	1.65	-	0.066	
L2	i	1.78	i	0.070	
L3	0.25	BSC	0.010	BSC	
L4	4.78	5.28	0.188	0.208	

ECN: S-82110-Rev. A, 15-Sep-08 DWG: 5970

- 1. Dimensioning and tolerancing per ASME Y14.5M.
- 2. Dimensions are shown in millimeters (inches).
- 3. Dimension D and E do not include mold flash. Mold flash shall not exceed 0.127 mm (0.005") per side. These dimensions are measured at the outmost extremes of the plastic body at datum A.
- 4. Thermal PAD contour optional within dimension E, L1, D1 and E1.
- 5. Dimension b1 and c1 apply to base metal only.
- 6. Datum A and B to be determined at datum plane H.
- 7. Outline conforms to JEDEC outline to TO-263AB.



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